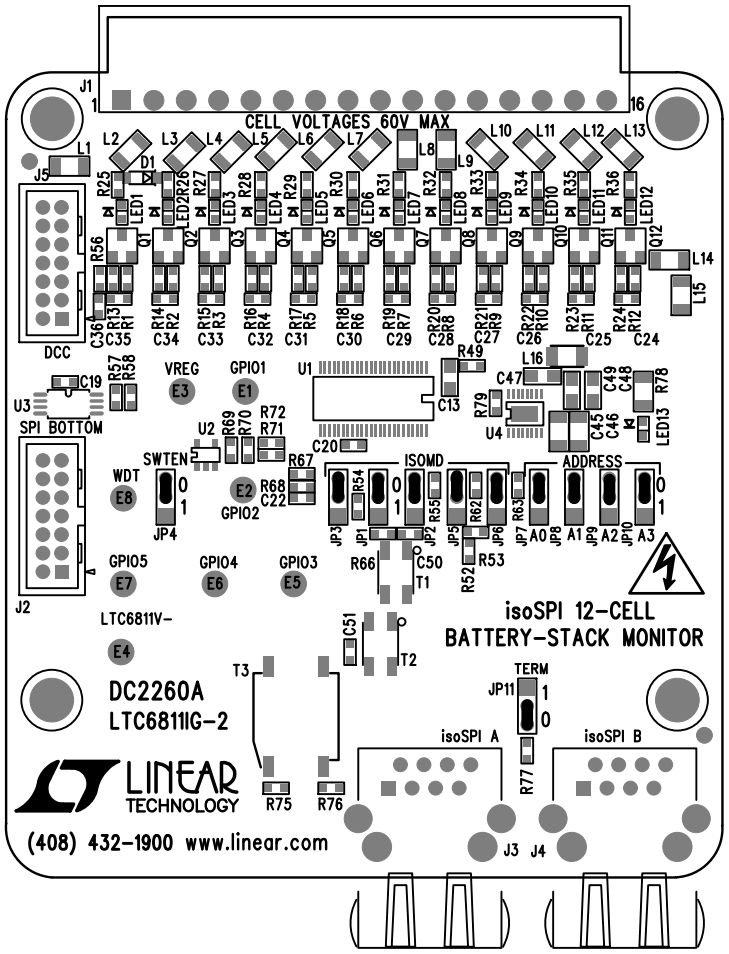
REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
–	1	2ND PROTOTYPE	JON M.	06-15-15



TOP SILKSCREEN

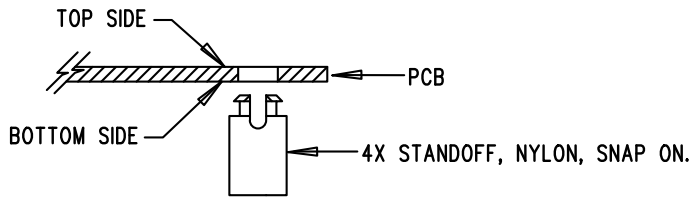
LINEAR TECHNOLOGY DATE: 06-15-15

DC2260A-2- LTC6811IG-2

isoSPI 12-CELL BATTERY-STACK MONITOR

NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. INSTALL 4 STANDOFFS AT 4 LOCATIONS AS SHOWN BELOW:



APPROVALS	
PCB DES.	AK
APP ENG.	JON M.
SCALE = NONE	

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TITLE: TOP ASSEMBLY DRAWING

isoSPI 12-CELL BATTERY-STACK MONITOR

SIZE	IC NO.	REV.
N/A	LTC6811IG-2 DEMO CIRCUIT 2260A	2

FILENAME: DC2260A-2.PCB SHT 1 OF 2